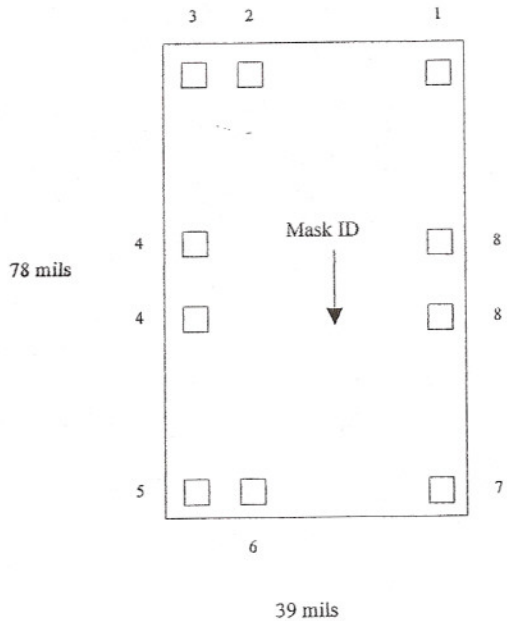




Sierra Components, Inc.

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PAD FUNCTION

- 1 V_{OUT1}
- 2 V_{BIV1}
- 3 V_{NON-INV1}
- 4 -V_{CC} (2 bond pads)
- 5 V_{NON-INV2}
- 6 V_{BIV2}
- 7 V_{OUT2}
- 8 +V_{CC} (2 bond pads)

NOTE: Chip back may be connected to -V_{CC} or it may be floating.

Topside Metal: Aluminum
Backside Metal: Silicon
Backside Potential: -V_{CC}
Bond Pad Size: .004" min.
Mask Ref: 62

APPROVED BY:

DIE SIZE: .039" x .078"

DATE: 1/13/04

MFG: National

THICKNESS: .014"

P/N: CLC412ALC

DG 10.1.2
 Rev A 3-4-99